Engineering Ferroelectric $Hf_{0.5}Zr_{0.5}O_2$ Thin Films by Epitaxial Stress

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ABSTRACT: The critical impact of epitaxial stress on the stabilization of the ferroelectric

orthorhombic phase of hafnia is proved. Epitaxial bilayers of Hf_{0.5}Zr_{0.5}O₂ (HZO) and La_{0.67}Sr_{0.33}MnO₃ (LSMO) electrodes were grown on a set of single crystalline oxide (001)-oriented (cubic or pseudocubic setting) substrates with lattice parameter in the 3.71 – 4.21 Å range. The lattice strain of the LSMO electrode, determined by the lattice mismatch with the substrate, is critical in the stabilization of the orthorhombic phase of HZO. On LSMO electrodes tensile strained most of the HZO film is orthorhombic, whereas the monoclinic phase is favored when LSMO is relaxed or compressively strained. Therefore, the HZO films on TbScO₃ and GdScO₃ substrates present substantially enhanced ferroelectric polarization in comparison to films on other substrates, including the commonly used SrTiO₃. The capability of having epitaxial doped HfO₂ films with controlled phase and polarization is of major interest for a better understanding of the ferroelectric properties and paves the way for fabrication of ferroelectric devices based on nanometric HfO₂ films.

1. INTRODUCTION

The recent demonstration of ferroelectricity in nanometric thin films of a metastable orthorhombic phase of doped HfO₂¹ opens promising opportunities for memory devices²⁻⁴ and energy applications.^{2,5-7} The metastable phase of HfO₂ is usually crystallized by annealing thin film heterostructures of amorphous hafnia sandwiched between top and bottom electrodes, typically TiN ^{2,8-9} or TaN.¹⁰ The resulting films are polycrystalline and contain paraelectric tetragonal and monoclinic phases besides the ferroelectric orthorhombic phase.^{1,2,11-12} The ferroelectric phase has been also grown epitaxially on a few substrates, including yttria-stabilized zirconia,¹³⁻¹⁶ LaAIO₃,¹⁷ SrTiO₃,¹⁸⁻²¹ and buffered Si.²² The research on epitaxial stabilization is just emerging in comparison with that on polycrystalline doped HfO₂ films.^{2,5,8,10-12,23} However, epitaxial HfO₂ films are of huge interest as their properties can be better controlled than those of polycrystalline samples. Besides the single crystal orientation in epitaxial films, the control of the epitaxial stress can permit engineering of the microstructure and the resulting ferroelectric properties of the films. The relevance of epitaxial stress on the

growth of ferroelectric HfO₂ is two-fold. On one hand, epitaxial stress affects greatly the

> energy of a (semi)coherent interface between a substrate and a heteroepitaxial film, and it can favor the stabilization of a metastable phase that is in competition with other polymorphs. This epitaxial stabilization has been used to obtain unstable phases of a variety of complex oxides.²⁴⁻²⁷ On the other hand, epitaxial stress can cause elastic lattice strain, which can modify the energy of the polymorphs^{23,28,29} and can also produce important effects on the polarization of ferroelectric oxides.³⁰⁻³¹ The most common method to control stress in heteroepitaxial films is based on the selection of a substrate with particular lattice mismatch. However, this substrate engineering remains unexplored for ferroelectric HfO₂.

> Aiming to investigate the effects of epitaxial stress, epitaxial $Hf_{0.5}Zr_{0.5}O_2$ (HZO) films were grown on a set of single crystalline oxide substrates presenting a wide range of lattice parameters (**Figure 1**a). $La_{0.67}Sr_{0.33}MnO_3$ (LSMO) epitaxial electrodes and HZO films were sequentially deposited in a single process. The lattice parameter of LSMO is expected to be critical on the epitaxial stabilization of HZO since the electrode is the

epitaxial template on which HZO grows. It is found that the substrate determines the lattice strain of LSMO, and that the LSMO strain state strongly influences the formation of orthorhombic and monoclinic phases in the HZO film. Therefore, the substrate determines the amount of orthorhombic phase, and substrate selection permits tuning of the ferroelectric polarization of the film. The remnant polarization Pr ranges from less than 5 μ C/cm² for films on LSAT (a_s = 3.868 Å) and substrates with smaller lattice parameter to around 25 μ C/cm² for films on TbScO₃ (a_s = 3.96 Å) and GdScO₃ (a_s = 3.97 Å). The results demonstrate that tensile strained LSMO electrodes favor the epitaxial stabilization of the metastable orthorhombic phase and enhancement of the ferroelectric polarization. Therefore, epitaxial stress engineering can be successfully applied to HfO₂, allowing control of the ferroelectric properties and making possible increased polarization. This control, which does not require varying thickness or deposition parameters, can pave the way to understand the correlations between structural and ferroelectric properties of HfO₂, and it is relevant for prototyping devices based on nanometric HfO₂ films.

2. RESULTS AND DISCUSSION

Figure b shows X-ray diffraction (XRD) θ-2θ symmetric scans of the HZO/LSMO/substrate samples. The position of the LSMO 002 reflection, in the $2\theta = 44$ - 49° range, depends strongly on the substrate. The corresponding LSMO out-of-plane (oop) lattice parameters are presented in **Figure 1**c as a function of the lattice mismatch with the substrate. The in-plane (ip) lattice parameters, determined from reciprocal space maps (RSM) around asymmetrical reflections (Figure S1), are also shown. Increasing lattice mismatch from around -2% to 2% (see the zoom in Figure 1d), reduces the LSMO oop parameter monotonously from ~4.00 Å (on LaAIO₃) to ~3.80 Å (on TbScO₃), whereas the corresponding ip parameter increases to \sim 3.79 Å to \sim 3.95 Å. The RSMs in Figure S1 confirm that LSMO films, 25 nm thick, are elastically strained in the -2 to +2% lattice mismatch range. In the films on substrates having larger negative or positive lattice mismatch, the LSMO relaxes plastically and the oop and ip parameters approach the bulk value, almost matching it on the greatly mismatched (<-

4.1%) YAIO₃ and (>8%) MgO substrates. Therefore, it is proven that the strain state of LSMO is determined by the substrate.

The LSMO electrodes act as a template for the subsequent growth of HZO, and thus their lattice strain, that depends on the substrate, can be relevant to the epitaxy of HZO. The XRD θ -2 θ scans in **Figure 1**b show orthorhombic (o) HZO(111) at 2 θ ~30° and/or monoclinic (m) HZO(002) at 20 ~34° diffraction peaks. The m-HZO peak can include contribution of 200, 020 and 002 reflections. The peaks are broad due to the nanometric thickness of the layers (~9.5 nm). The amount of each phase depends on the substrate. In the case of the substrates with lattice parameter from 3.905 Å (SrTiO₃) to 4.01 Å $(NdScO_3)$, the o-HZO(111) peaks have high intensity and Laue fringes can be seen (**Figure S2**). The XRD 20- γ frames of all samples, presented in **Figure 2**a, reflect the impact of the substrate on the HZO phases. It is noticed that the o-HZO 111 is a bright circular spot, whereas the m-HZO 002 reflection is generally elongated along χ , signaling higher mosaicity (excluding the film on LaAlO₃, which m-HZO 002 reflection is a bright spot). To map the formation of orthorhombic and monoclinic phases as a

function of the substrate, the intensity at each 20 was integrated from χ = -10° to χ = +10° for each frame (Figure 2b). The intensity is plotted in a logarithmic color scale and the 20 scans are shifted vertically, ordered as the lattice parameter of the substrate increases (see labels at the right). The 001 reflections of substrate (marked with red dashed line) and LSMO electrode (marked with black dotted line) are at 20 angles from around 20° to 26°, and the corresponding 002 reflections are from around 40° to 50°. The o-HZO 111 and the m-HZO 002 reflections are at around 30° and 34°, respectively. The map shows that the orthorhombic phase is mainly present on substrates with lattice parameter from 3.905 Å (SrTiO₃) to 4.01 Å (NdScO₃), and that basically pure orthorhombic phase films only are obtained on DyScO₃, TbScO₃, and GdScO₃. Figure 2b indicates that the orthorhombic phase is favored on substrates with large lattice parameter, whereas the amount of monoclinic phase is greater when the lattice parameter of the substrate is smaller. The films on substrates with very large or very small lattice parameter do not follow this tendency, which is likely due to the plastic relaxation of the LSMO electrode. Indeed, the plot of the intensity of the reflections of both phases shows monotonic dependences on the ip lattice parameter of LSMO

(Figure 2c). The orthorhombic phase forms when the ip parameter of the LSMO template is larger than around 3.87 Å, and the XRD o-HZO 111 spot intensity increases with the LSMO ip parameter. The monoclinic phase shows an opposite tendency, and it is only absent when the LSMO template has an elongated ip parameter around 3.95 Å. The intensity of orthorhombic and monoclinic XRD reflections depends strongly on the ip parameter of the LSMO electrode (Figure 2c). It shows that depending on the strain of the LSMO electrode, either pure monoclinic phase, mixture of both phases, or pure orthorhombic films are obtained. In contrast, the lattice parameter of the LSMO template has little influence on the interplanar $d_{o-HZO(111)}$ spacing (Figure 2d), and only a slight $d_{o-HZO(111)}$ HZO(111) contraction, close to the detection limit, can be appreciated in the films on electrodes with largest a_{LSMO}. This suggests plastic relaxation, which is confirmed by XRD reciprocal space maps (Figure S3).

Polymorphs that are unstable in bulk materials can form in thin films due to the change in energy in case of elastic strain and the contribution of surface and interface energies. Density functional (DFT) calculations^{23,28,29} predict for HfO₂ that compressive strain and surface energy contribution reduce the energy of the polar orthorhombic

phase with respect to the monoclinic one. Thus, the formation of the polar phase is

more favored in ultrathin films where the surface energy contribution is more relevant. These DFT calculations considered films having {100} ^{23,28} and {110} ³² orientations. Very recently, DFT calculations were extended to (111) orientation, and remarkably it was found that the orthorhombic phase in (111)-oriented films has minimum energy for positive strain around 1.5%, and its energy was smaller than that of (111)-oriented monoclinic phase for a very broad range of strain extending from negative values to positive values well above 2%.²⁹ Therefore, the o-HZO(111) orientation in our epitaxial films can be a relevant factor on the stabilization of the ferroelectric phase, although its formation in our films is competing with the {100} orientation of the monoclinic phase. On the other hand, strain is likely less relevant considering the low elastic strain (Figure S3) of the films. In addition, the interface between HZO and the bottom surface (the LSMO electrode in this case), for which energy calculations are not reported, can be determinant on the total energy of HZO polymorphs. The epitaxial stabilization of o-HZO with (111)-orientation implies a change in crystal symmetry, being the HZO film (111) oriented on the 4-fold symmetry LSMO(001) surface. Heteroepitaxy with different

symmetry between a top layer and a bottom layer (or the substrate) is relatively frequent.³³ Films can present either higher³⁴ or lower³⁵ symmetry than the substrate. Epitaxy requires matching between layer and substrate crystal lattices, which is intriguing when the surface symmetry of layer and substrate is different. However, heteroepitaxy can happen in largely mismatched film-substrate systems by coincidence of m lattice planes of the film on n planes of the substrate.³⁶ This mechanism is often observed in heteroepitaxy of semiconductors³⁶ and oxides³⁷. The change in symmetry usually causes formation of crystal variants, like in the case of o-HZO(111) films on LSMO(001) surfaces. Related examples are epitaxial growth of spinel NiFe₂O₄(111) films on yttria-stabilized zirconia-YSZ(001)³⁸ or wurtzite ZnO(0001) on MgO(001)³⁵.

XRD pole figures around asymmetrical o-HZO -111 and m-HZO -111 reflections in **Figure 3**a, confirm that both orthorhombic and monoclinic phases, when present in the films, are epitaxial (see ϕ -scans in **Figure S4**). The sample on GdScO₃ shows 4 sets of three high intensity o-HZO -111 spots, indicating the existence of four crystal variants with 90° rotation in the plane. In **Figure 3**c the epitaxial relationship is sketched. The rhombohedral distortion reported²⁰ in similar HZO films on LSMO(001) electrodes is not

observed here within the sensitivity of the XRD measurements. In the films on substrates with smaller lattice parameter, SrTiO₃ and LSAT, the intensity of the o-HZO - 111 reflections decreases, and they are not observed in the film on LaAIO₃. In contrast, the poles around m-HZO -111, show four intense spots in the film on LaAIO₃, lower intensity spots on LSAT and SrTiO₃, and barely detectable on GdScO₃. The epitaxial relationship of this phase is sketched in **Figure 3**d.

Topographic atomic force microscopy (AFM) images of HZO/LSMO bilayers on NdScO₃, DyScO₃, LSAT, and LaAlO₃ are shown in **Figures 4** (a-d), respectively. The films are very flat, with root means square (rms) roughness less than 5 Å, and a morphology of terraces and steps can be appreciated in some of the images. The surface flatness of all the films is remarkable considering the broad range of lattice parameter of the substrates. In **Figure S5** we show AFM images of all the samples and the rms roughness is plotted as a function of the lattice parameter of the substrate. It is seen that roughness increases from around 2 Å to 4 - 5 Å with the substrate lattice parameter.

Scanning transmission electron microscopy (STEM) has been used for structural characterization at the nanoscale and to identify the orthorhombic and monoclinic phases in HZO films on three substrates with fully strained LSMO electrodes: i) LSAT, with lattice parameter ($a_s = 3.868$ Å) and the best lattice matching with bottom LSMO electrode, ii) SrTiO₃, with larger lattice parameter $a_s = 3.905$ Å, which has been already used¹⁸⁻²⁰ for epitaxial growth of o-HZO(111), and iii) GdScO₃, with much larger lattice parameter ($a_s = 3.97$ Å). The corresponding cross-sectional high-angle annular dark field (HAADF) images are presented in **Figures 5**a-c, respectively. The low magnification (top panels) and high magnification (bottom panels) images were obtained along the [110] zone axes of the substrates. The low magnification images show a clear contrast between the HZO film, LSMO electrode, and substrate. In order to properly identify the phases, their orientation and epitaxy, HAADF images are compared with the orthorhombic and monoclinic projected structures. High magnification images of the HZO film on LSAT (Figure 5a, bottom panel) confirm the presence of the monoclinic phase (see the inset), and the absence of the orthorhombic phase in the imaged section. In contrast, orthorhombic and monoclinic HZO crystallites coexist in the film on

SrTiO₃. Insets in **Figure 5**b, bottom panel, show enlarged views of the monoclinic and the orthorhombic grains, with the projected structures superimposed. The lateral size of orthorhombic grains is around 10 \pm 4 nm, while a slightly larger lateral size around 15 \pm 5 nm is found for the monoclinic phase. Finally, the HZO film on $GdScO_3$ only presents orthorhombic grains (see the inset in bottom panel of Figure 5c), with absence of monoclinic phase in the imaged section. The epitaxial relationship for the orthorhombic phase is [1-10]o-HZO(111)//[1-10]LSMO(001)//[1-10]Substrate(001), where all the indices refer to the cubic or pseudocubic unit cells. For the m-phase, the epitaxial relationship is [010]m-HZO(001)//[1-10]LSMO(001)//[1-10]Substrate(001). These results demonstrate the huge impact of the substrate lattice parameter in the formation of monoclinic or orthorhombic HZO phase.

Ferroelectric polarization loops of the HZO films deposited on the different substrates are shown in **Figure 6**a. Detailed information about the ferroelectric measurement is presented in **Figure S6**. In agreement with the critical role of the substrate on the stabilization of the orthorhombic phase, the ferroelectricity is found to depend strongly on the substrate. The HZO films on the substrates with smaller lattice parameter, YAIO₃,

LaAlO₃ and NdGaO₃, have low ferroelectric polarization of about 4 μ C/cm². HZO films on substrates having larger lattice parameter show an increasing remnant polarization (P_r) from around 5 μ C/cm² on LSAT to around 24 μ C/cm² on TbScO₃. With further increase of the lattice parameter of the substrate, the polarization of HZO becomes progressively smaller, getting reduced to 9 µC/cm² in the film on MgO. The remnant polarization is plotted against the substrate lattice parameter in **Figure 6**b, showing a peaked dependence with largest polarization for HZO films on scandates with lattice parameter around 3.96 Å. It should be noted that the HZO films do not grow directly on the substrate but on the LSMO bottom electrode that is fully strained only on substrates with lattice parameter in the 3.79 – 3.97 Å range. Indeed, the plot of the remnant polarization against the ip parameter of the LSMO electrode shows very low polarization when a_{LSMO} is smaller than around 3.87 Å, and continuous linear increase for larger a_{LSMO} parameter (**Figure 6**c).

Two potential contributions to the ferroelectric polarization can be considered. First, the amount of orthorhombic phase formed, and second the strain state of the resulting o-HZO(111) phase (**Figures 1-3**). These two contributions can ultimately determine the

ferroelectric polarization. Therefore, the remnant polarization is plotted as a function of the interplanar d_{o-HZO(111)} spacing (**Figure 7**a) and the normalized intensity of the XRD o-HZO 111 reflection (**Figure 7**b). The films with shorter interplanar d_{o-HZO(111)} spacing appear to have larger polarization, but the graph does not show a clear dependence as error bars in lattice parameter are comparable to its variation. In contrast, **Figure 7**b clearly confirms that samples with the largest amount of orthorhombic phase (mainly on scandate substrates) also have the largest polarization. Thus, the role of epitaxial stress is unraveled: 1) it conditions the epitaxial stabilization of the orthorhombic phase, and 2) the amount of this phase determines the ferroelectric polarization. The impact is critical and films on scandate substrates present greatly enhanced ferroelectric properties.

3. CONCLUSIONS

In conclusion, the role of epitaxial stress on the stabilization of the metastable orthorhombic phase of HZO has been unraveled. LSMO bottom electrodes are elastically strained in a range of lattice mismatch from around -2 to 2 %, and thus HZO

films can be integrated in capacitor heterostructures with a broad range of epitaxial stress by selection of the substrate. The amount of stabilized orthorhombic phase is enhanced on substrates with pseudocubic lattice parameter larger than around 3.87 Å. The orthorhombic HZO phase becomes strongly favored with respect to the monoclinic HZO phase for increasing substrate lattice parameters, as long as the fully strained state of the LSMO is maintained. TbScO₃ and GdScO₃ are the optimal substrates to stabilize the orthorhombic HZO phase, with negligible amount of paraelectric phase and much higher polarization than that of films on SrTiO₃ or LSAT substrates. Epitaxial ultrathin HZO films with enhanced properties on TbScO₃ and GdScO₃ substrates could be used in emerging devices such as ferroelectric tunnel junctions, with superior performance than epitaxial films on $SrTiO_3(001)$.

EXPERIMENTAL SECTION

Thin films deposition: Epitaxial bilayers formed by top HZO films and bottom LSMO bottom electrodes (t = 25 nm) were grown in a single process by pulsed laser deposition

(KrF excimer laser). A set of ten (001)-oriented cubic and (110)-oriented rhombohedral and orthorhombic substrates were used. For the sake of simplicity, pseudocubic cell is used here for the rhombohedral and orthorhombic substrates, being their orientation (001) in this setting. The lattice (cubic or pseudocubic) parameter of the used substrates is in the $a_s = 3.71 - 4.21$ Å range (**Figure 1**a). The HZO films, 9.5 nm thick, were deposited at substrate temperature of 800 °C under dynamical oxygen pressure of 0.1 mbar. Additional information on growth conditions of HZO and LSMO is reported elsewhere.¹⁸⁻¹⁹

Structural characterization: The crystal structure (crystal phases of HZO and lattice parameters of LSMO and HZO) was characterized by X-ray diffraction using Cu K α radiation. A Siemens D5000 diffractometer with point detector was used to measure symmetric 2 θ scans. A Bruker D8, equipped with 2d detector Vantec 500, was used to acquire 2θ - χ frames and pole figures around o-HZO -111 and m-HZO -111 asymmetric reflections. Atomic force microscopy in dynamic mode was used to characterize surface topography. Microstructural characterization of selected samples was done by scanning transmission electron microscopy using a Nion UltraSTEM 200, operated at 200 kV and

equipped with a 5th order Nion aberration corrector, and a JEOL ARM 200CF STEM with a cold field emission source (equipped with a CEOS aberration corrector). Highangle annular dark field images of cross-sectional specimens were recorded along the [110] zone axes of the substrates. **Ferroelectric characterization**: Capacitor structures were obtained by *ex-situ*

deposition through stencil masks of top platinum electrodes, 20 nm in thickness and 19 µm in diameter, by dc magnetron sputtering. Ferroelectric polarization loops were obtained at room temperature in top-bottom configuration by means of an AixACCT TFAnalyser2000 platform. Leakage contribution was compensated using dynamic leakage current compensation (DLCC) standard procedure.³⁹⁻⁴⁰

ASSOCIATED CONTENT

Supporting Information. XRD reciprocal space maps around asymmetric LSMO reflections. Simulation of Laue fringes around o-HZO 111 reflection. XRD reciprocal space maps around asymmetric HZO reflections. XRD ϕ -scans around asymmetrical

reflections of o- and m-HZO phases. Topographic atomic force microscopy images of all

films. Information about measurement of ferroelectric polarization loops, including

current-voltage curves

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Figure 1. (a) Sketch showing the lattice mismatch between the LSMO electrode and the substrates used to deposit HZO/LSMO bilayers. The lattice mismatch (f) between LSMO and the substrates, defined as $f = 100x(a_s-a_{LSMO})/a_{LSMO}$, where a_{LSMO} and as are the lattice parameters of bulk LSMO and the substrate, respectively. Pseudocubic cell is

used for rhombohedral LaAlO $_3$ and orthorhombic (NdGaO $_3$ and scandates) substrates.
(b) XRD θ -2 θ symmetric scans of the HZO/LSMO bilayers. Scans are shifted vertically
according the lattice parameter of the substrate (see labels and arrow at the right).
Vertical solid line at 2θ = 30.1° marks the positions of the o-HZO 111 peak in the film on
SrTiO ₃ (001). The vertical dashed line marks the position of the (002) reflection in bulk
LSMO. Right: schematics of the strain state of LSMO depending on the lattice
parameter of the substrate. (c) Out-of-plane and in-plane lattice parameters of LSMO as
a function of the lattice mismatch with the substrate. (d) Zoom around the range of
lattice mismatch where LSMO is elastically strained.



Figure 2. (a) XRD 2θ - χ frames of the HZO/LSMO bilayers. The 2θ and χ ranges are from 20° to 52° and from -8° to $+8^{\circ}$, respectively. (b) Mapping of the orthorhombic and monoclinic phases as a function of the substrate lattice parameter. The 2θ scans were integrated from χ = -10° to $+10^{\circ}$ and the samples are ordered as the substrate lattice parameter increases. The change in the LSMO peaks position (marked with black dotted lines) on the used substrate (peaks position marked with red dashed lines) is

also visualized. (c) Intensity of the o-HZO(111) and m-HZO(002) peaks (calculated from gaussian fits) and (d) interplanar $d_{o-HZO(111)}$ spacing as a function of the ip lattice parameter of the LSMO electrode. The $d_{o-HZO(111)}$ spacing was determined by Gaussian fits of the 20 peak position, and the error bar is set to 1 σ of the fit.



Figure 3. XRD pole figures of (a) o-HZO -111 (O) and m-HZO -111 (M), and (b) m-HZO

-111 (M) reflections obtained for films on LaAlO₃, LSAT, SrTiO₃, and GdScO₃. The pole figures were measured in the range of χ from 35 to 80°. (c) Sketch of the epitaxial

relationship of the o-HZO phase (top view). (d) Top and cross-sectional views of the

epitaxial relationship of the m-HZO phase.



Figure 4. Topographic AFM images (5 µm x 5 µm) of HZO films on NdScO₃ (a), DyScO₃

(b), LSAT (c), and LaAlO $_3$ (d). The rms roughness is indicated in the top of each AFM

image.



Figure 5. Cross-sectional HAADF STEM images of HZO/LSMO films on (a) LSAT, (b) SrTiO₃, and (c) GdScO₃ substrates. The images were acquired along the [110] zone axes of the substrates. Top panels are low magnification images showing the substrate, the LSMO and the HZO films. Bottom panels are higher magnification images of the HZO and LSMO films. The insets show atomic-resolution images of the HZO films. Red and blue circles depict the monoclinic (space group P2₁/c) and orthorhombic (space group Pca2₁) structures, respectively.



Figure 6. (a) Ferroelectric polarization loops of the HZO films. Remnant polarization as a function of (b) the lattice parameter of the substrate and (c) the ip parameter of the

LSMO electrode.



Figure 7. (a) Remnant polarization as a function of the interplanar do-HZO(111) spacing. do-

 $_{\text{HZO(111)}}$ was determined by Gaussian fits of the XRD 20 peak position, and the error bar

is set to 1σ of the fit. (b) Remnant polarization as a function of the normalized intensity

of the XRD o-HZO 111 reflection.

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